

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
TZU-YU LIU	12/13/2014
KUO-CHUANG CHIU	12/13/2014
HUNG TIEN	12/13/2014
SHIOU-LAN HU	12/12/2014
YEH-CHYANG HUANG	12/12/2014
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<b>Postal Code:</b>	23547
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14583212
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	52614-US-PA
<b>NAME OF SUBMITTER:</b>	BELINDA LEE
<b>SIGNATURE:</b>	/Belinda Lee/
<b>PATENT</b>	

<b>DATE SIGNED:</b>	12/29/2014
<b>Total Attachments: 3</b> source=52614_asm#page1.tif source=52614_asm#page2.tif source=52614_asm#page3.tif	

## ASSIGNMENT

WHEREAS,

- |                     |                    |
|---------------------|--------------------|
| 1. Tzu-Yu Liu       | 2. Kuo-Chuang Chiu |
| 3. Hung Tien        | 4. Shiou-Lan Hu    |
| 5. Yeh-Chyang Huang |                    |

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: LIQUID CONCENTRATION DETECTING DEVICE

Filed: Serial No.

Executed concurrently with the execution of this instrument

WHEREAS

1. Industrial Technology Research Institute
of No. 195, Sec. 4, Chung Hsing Rd., Chutung, Hsinchu 31040, Taiwan, R. O. C.
2. Etian Technology Ltd.
of No.9, Ln. 294, Yuanshan Rd., Zhonghe Dist., New Taipei City 23547, Taiwan (R.O.C.)

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

## ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Tzu-Yu Liu Date: 2014. 12. 13  
Sole or First Joint Inventor: Tzu-Yu Liu

Signature: Kuo-Chuang Chiu Date: 2014. 12. 13  
Second Joint Inventor (if any): Kuo-Chuang Chiu

Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Third Joint Inventor (if any): Hung Tien

Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Fourth Joint Inventor (if any): Shiou-Lan Hu

Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Fifth Joint Inventor (if any): Yeh-Chyang Huang

### ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Sole or First Joint Inventor: Tzu-Yu Liu

Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Second Joint Inventor (if any): Kuo-Chuang Chiu

Signature: TIEN HUNG Date: 13.12.2014  
Third Joint Inventor (if any): Hung Tien

Signature: Shiou-Lan Hu Date: 12.12.2014  
Fourth Joint Inventor (if any): Shiou-Lan Hu

Signature: Yeh-Chyang Huang Date: 12.12.2014  
Fifth Joint Inventor (if any): Yeh-Chyang Huang